

TOSHIBA BIPOLAR LINEAR INTEGRATED CIRCUIT SILICON MONOLITHIC

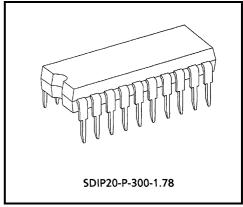
TA1226N

Y LUMINANCE TRANSIENT IMPROVER IC

TA1226N integrates Y luminance transient improver circuits (black stretch, DC transfer ratio compensation, super real transient, noise reduction) in a 20-pin shrink DIP. TA1226N functions are controlled via I²C bus.

FEATURES

- Black stretch circuit
- DC transfer ratio compensation circuit
- Super real transient circuit (SRT)
- Noise reduction
- 1-bit DAC output
- Velocity modulation output



Weight: 1.02g (Typ.)

The products described in this document are subject to the foreign exchange and foreign trade laws.

TOSHIBA is continually working to improve the quality and reliability of its products. Nevertheless, semiconductor devices in general can malfunction or fail due to their inherent electrical sensitivity and vulnerability to physical stress. It is the responsibility of the buyer, when utilizing TOSHIBA products, to comply with the standards of safety in making a safe design for the entire system, and to avoid situations in which a malfunction or failure of such TOSHIBA products could cause loss of human life, bodily injury or damage to property.

damage to property.

In developing your designs, please ensure that TOSHIBA products are used within specified operating ranges as set forth in the most recent TOSHIBA products specifications. Also, please keep in mind the precautions and conditions set forth in the "Handling Guide for Semiconductor Devices," or "TOSHIBA Semiconductor Reliability Handbook" etc...

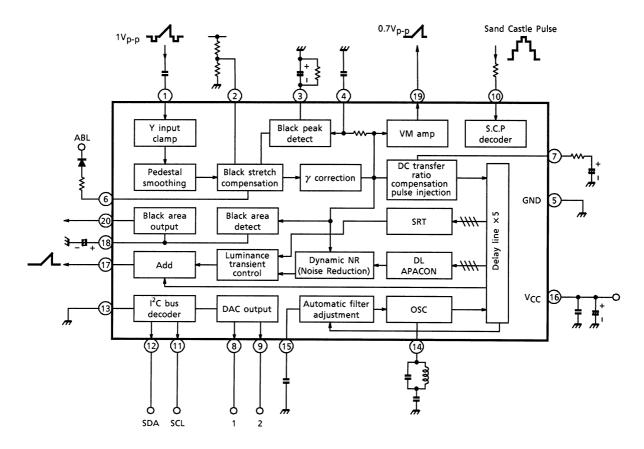
The TOSHIBA products listed in this document are intended for usage in general electronics applications (computer, personal equipment, office equipment, measuring equipment, industrial robotics, domestic appliances, etc.). These TOSHIBA products are neither intended nor warranted for usage in equipment that requires extraordinarily high quality and/or reliability or a malfunction or failure of which may cause loss of human life or bodily injury ("Unintended Usage"). Unintended Usage include atomic energy control instruments, airplane or spaceship instruments, transportation instruments, traffic signal instruments, combustion control instruments, medical instruments, all types of safety devices, etc.. Unintended Usage of TOSHIBA products listed in this document shall be made at the customer's own risk. shall be made at the customer's own risk.

The information contained herein is presented only as a guide for the applications of our products. No responsibility is assumed by TOSHIBA CORPORATION for any infringements of intellectual property or other rights of the third parties which may result from its use. No license is granted by implication or otherwise under any intellectual property or other rights of TOSHIBA CORPORATION or others

The information contained herein is subject to change without notice.



BLOCK DIAGRAM



TERMINAL CONNECTION DIAGRAM

20)	(19)	(18)	(17)	(16)	(15)	(14)	(13)	(12)	(11)
Black area output	VM Y output	Black area hold	Y output	VCC	Automation filter adjustmen	030	Digital GND	SDA	SCL
)				TA12	26N				
Y input	Black stretch point	Black peak hold	Black detect level	Analog GND	ARL	transfer ratio npensation	DAC1 output	DAC2 output	SCP input
1	2)	(3)	4)	(5)	6	7)	(8)	9	10

TERMINAL FUNCTION

Pin No.	PIN NAME	FUNCTION	INTERFACE	I / O SIGNAL
1	Y input	Luminance signal input pin. Input luminance signal after eliminating chrome signal via capacitor. After luminance signal is input to this pin, Y signal is clamped to 4.5V pedestal level. Standard input level is $1V_{p-p}$ (including sync signal).	1κΩ 1κΩ 1κΩ 1κΩ 1κΩ	1V _{p-p} 4.5V (Typical) GND
2	Black stretch point	Used to set black stretch start point using external resistance (DC level). Note that setting this pin to 1.5V or below enters test mode. (IRE) 50 4.0 4.5 5.0 Fin 2 voltage	2 5κΩ 10κΩ	DC 3.5~7.0V
3	Black peak hold	Used to connect filter which detects highest black level of luminance signal. Voltage on this pin determines black stretch gain.	© 7.5kΩ + 100Ω M 4.5V	DC 3.8~5.2V
4	Black detect level	Used to control frequency (area) of black level to be detected. Set area to be detected using external capacitance and internal resistance. In application circuit example, setting is made so that frequency of black level to be detected is 100kHz or less.	4.5v 2×2v 10kΩ	0.7V _{p-p} 4.5V (Typical)

Pin No.	PIN NAME	FUNCTION	INTERFACE	I / O SIGNAL
5	Analog GND	GND for analog circuit	_	_
6	ABL input	Used to apply control current for ABL and black level compensation. (IRE) 15 10 10 10 20 30 Output current (µA)	6	_
7	DC transfer ratio compensati- on	Used to compensate DC transfer ratio. Smaller Rx, larger compensation amount. Injection of Rz varies start point of DC transfer ratio compensation. DC transfer ratio TDC (%) =5kΩ / (5kΩ+Rx)×30+100 Rx small (no Rz) Rx large (no Rz) Rx large (no Rz) Rx small (No Rz)	$7 \qquad \begin{array}{c} 5k\Omega \\ 2k\Omega \\ 1.2k\Omega \\ \end{array}$	When pin 7 is open : 0.7V _{p-P} 4.5V (Typical)
8	DAC1 output DAC2 output	Open collector switches. Maximum, input current value : 2mA (minimum, drive resistance value : 6kΩ)	8 500Ω	DC V _{CC} or GND
10	SCP input	SCP (Sand Castle Pulse) input pin. Typical thresholds for CP (Clamp Pulse), HP (Horizontal Pulse), and VP (Vertical Pulse) are 6.9V, 3.1V, and 1.3V respectively.	10 30kΩ C 30kΩ	

Pin No.	PIN NAME	FUNCTION	INTERFACE	I / O SIGNAL
11	SCL	I ² C bus SCL pin. Because surge breakdown voltage is low, take external countermeasure if necessary.	SCI NAME OF THE PROPERTY OF TH	5v 0v
12	SDA	I ² C bus SDA pin. Because surge breakdown voltage is low, take external countermeasure if necessary. When Vcc voltage is 3.2V or more, power-on reset is applied.	12 50Ω ACK SDA M M M M M M M M M M M M M M M M M M M	ACK bit 0V
13	Digital GND	Logic circuit GND pin.	_	_
14	osc	Used to connect filter for obtaining 4MHz. Using 4-MHz oscillation, automatically adjusts built-in delay line.	14	DC 11.7V (Typical) AC 420mV _{p-p} (Typical) (at 4MHz)
15	Automatic filter adjustment	Used to connect filter which automatically adjusts delay time of IC built-in delay line. Directly connecting external pull-up resistor increases peak frequency. Pulling down decreases peak frequency.	15 10kΩ 10kΩ 10kΩ	DC 5.9V (Typical)

Pin No.	PIN NAME	FUNCTION	INTERFACE	I / O SIGNAL
16	VCC	V _{CC} pin. Connect 12V (typical).	_	_
17	Y output	Output pin for luminance signal on which Y is processed. Max. output current value : 2mA (min. drive resistance value : $3.8k\Omega$)	1mA 1kD 50000	0.7V _{p-p} 7.8V (Typical) GND
18	Black area hold	Used to connect filter which detects black area of input luminance signal. Voltage changes depending on black area of input signal pin. Black area detection of bus control can vary threshold of black area detect.	8 1 2 2 2 2 2 2 2 2 2 2 2 2 2 2 2 2 2 2	DC 0.2~6.7V
19	Y output for VM	Y output pin for VM (Velocity Modulation). Maximum output current value : 2mA (minimum drive resistance : 2.4kΩ).	1kΩ	0.7V _{p-p} 3.75V (Typical) GND
20	Black area output	Output pin for black area detected by black area hold circuit. Outputs DC current depending on input black area. Larger black area, higher pin voltage. Control is possible using output of this pin, depending on input signal black area.	200 W 5KD 1KD	DC 0.5~6.8V



BUS CONTROL MAP

Y luminance	/ luminance transient improver IC						Slave address : 10111010 (BA (h))			
SUB ADDRESS	7 MSB	6	5 4 3 2 1 0 LSD			POWE INITIAL MSB	R-ON VALUE LSB			
00	APAC			Sharpness				0100	0000	
01	Black ar	ea detect	SRT	SRT level *		YNR	γ correction		0000	1011
02	DAC1	DAC2	VM	VM gain		γ curve	Black compens a-tion	SRT	0011	0011
03	TE	ST		Frequency character compensation (R		Luminance transient tracking (RTC)		1100	0100	

Note *: Ignore data.

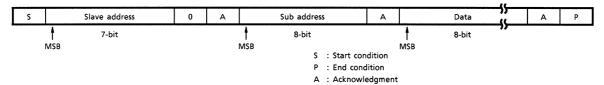
FUNCTION	CONTRO	DL DATA	CONTROL CONTENTS	PRESET VALUE
APACON	0 : ON 1 : OFF		Controls ON / OFF of DL (Delay Line) APACON in micro signal amplitude (approx. 20mV _{p-p}) range.	ON (0)
Sharpness	7F : MAX 00 : MIN		Controls both DL APACON and SRT.	Center value (40h)
Black area detect	11 : 40 IRE 01 : 20 IRE	10 : 30 IRE 00 : 10 IRE	Controls maximum level of black area detect from pedestal of black area detector circuit (pin 20 output).	10 IRE (00)
SRT level	11 : 28 IRE 01 : 10 IRE	10 : 14 IRE 00 : 7 IRE	Controls signal amplitude at which SRT becomes valid.	28 IRE (00)
YNR	0 : ON 1 : OFF		Controls YNR ON / OFF.	OFF (1)
γ correction	11 : OFF 01 : 80 IRE	10 : 90 IRE 00 : 70 IRE	Controls start point of γ correction (broken line at one point)	OFF (11)
DAC1	0 : OPEN 1 : ON		Controls 1-bit DAC (open collector transistor output)	OPEN (0)
DAC2	0 : OPEN 1 : ON		Controls 1-bit DAC (open collector transistor output)	OPEN (0)
VM gain	11: 0dB 01:-6dB	10 : -3dB 00 : OFF	Controls gain between Y input and VM output.	0dB (00)
Black stretch	0 : ON 1 : OFF		Controls black stretch ON / OFF.	OFF (0)
γ curve	0:-2.4dB 1:-1.6dB		Controls curve of γ correction (broken line at one point)	-2.4dB (0)
Black compensation	0 : ON 1 : OFF		Controls automatic black level compensation (max. 7.5IRE). (When black stretch gain is maximum, if highest black level floats above pedestal level, DC-shifts maximum of 7.5IRE picture duration up to pedestal level.)	ON (0)
SRT	0 : OFF 1 : ON		Controls SRT ON / OFF.	ON (1)
TEST	11 : Test3 01 : SHR	10 : RTC 00 : RS	Controls pin 20 output signal in test mode.	Test3 (11)
8MHz frequency characteristics compensation	111 : MAX (+6dB) 000 : MIN (0dB)		Controls gain of DL APACON at 8MHz peak.	0dB (000)
Luminance transient tracking	111 : MAX 000 : MIN		Controls compensation ratio of SRT and DL APACON. (Controls SRT level to be added to DL APACON.)	Center value (100)



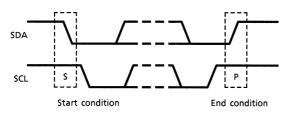
OVERVIEW OF I²C BUS CONTROL FORMAT

The bus control format for TA1226N conforms to the Philips standard.

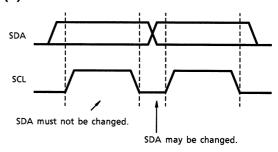
Data transfer format



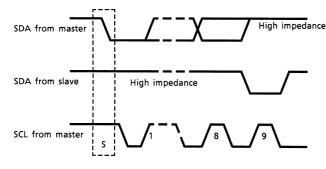
(1) Start and end conditions



(2) Bit transfer



(3) Acknowledgment



(4) Slave addresses

A6	A5	A4	А3	A2	A1	A0	R/\overline{W}
1	0	1	1	1	0	1	

Purchase of TOSHIBA I^2C components conveys a license under the Philips I^2C Patent Rights to use these components in an I^2C system, provided that the system conforms to the I^2C Standard Specification as defined by Philips.



MAXIMUM RATINGS (Ta = 25±3°C)

CHARACTERISTIC	SYMBOL	RATING	UNIT
Supply Voltage	V _{ccmax}	14	V
Input Pin Signal Voltage	ein _{max}	12	V _{p-p}
Power Dissipation	P _D (Note 1)	1400	mW
Power Dissipation Decrease Ratio	1 / Qjp	-11.2	mW / °C
Operating Temperature	T _{opr}	-20~65	°C
Storage Temperature	T _{stg}	-55~150	°C

Note 1: See figure below.

Note 2: Since the device is susceptible to surge voltage, take great care when handling.

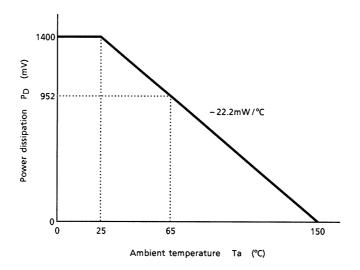


Figure Temperature decrease curve of power dissipation

RECOMMENDED SUPPLY VOLTAGE

PIN No.	PIN NAME	MIN	TYP.	MAX	UNIT
16	V _{CC}	11.0	12.0	13.0	V

ELECTRICAL CHARACTERISTICS (Unless otherwise specified, V_{CC} = 12V, Ta = 25±3°C) DC characteristics Supply voltage

CHARACTERISTIC	SYMBOL	MIN	TYP.	MAX	UNIT
Supply Voltage	I _{CC}	26.0	35.5	48.0	mA

Pin voltage

PIN No.	PIN NAME	SYMBOL	MIN	TYP.	MAX	UNIT	REMARKS	
1	Y input	V1	4.20	4.50	4.80		No input, SCP input	
4	Black detect level	V4	4.20	4.50	4.80		No iliput, 30F iliput	
6	ABL input	V6	2.00	2.50	2.90			
7	DC transfer ratio compensation	V7	4.20	4.50	4.80	V	No input, Pin open, SCP input	
8	DAC1 output	V8	11.5	11.9	12.0			
9	DAC2 output	V9	11.5	11.9	12.0		No input SCR input	
17	Y output	V17	7.45	7.80	8.15		No input, SCP input	
19	VM Y output	V19	3.30	3.75	4.20			

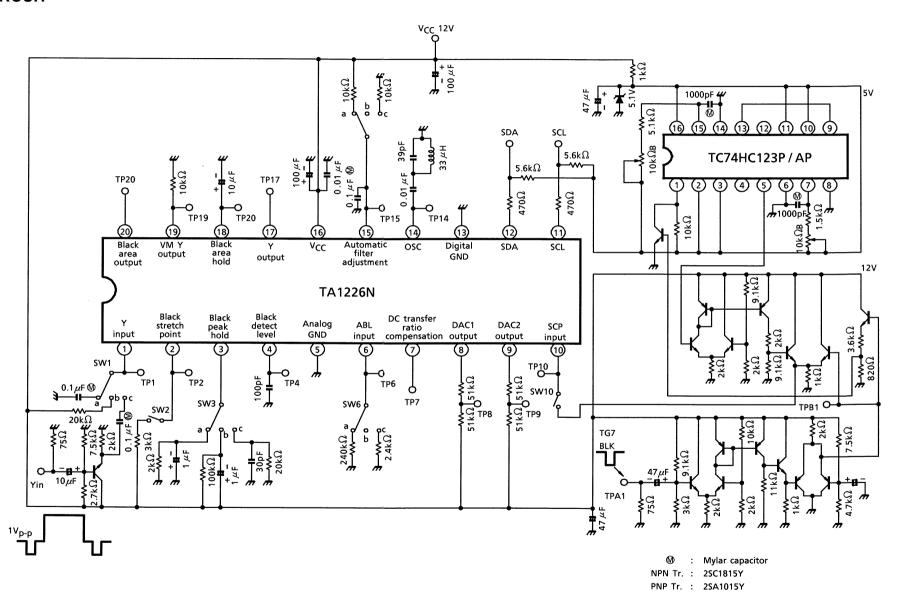
AC characteristics (Unless otherwise specified, V_{CC} = 12V, Ta = 25±3°C)

CHARACTERISTIC	SYMBOL	TEST CIR- CUIT	TEST CONDITION	MIN	TYP.	MAX	UNIT
Y Input Pedestal Clamp Voltage	V1	_	(Note 1)	4.2	4.5	4.8	V
Pin 7 Output Impedance	Z _{OUT7}	_	(Note 2)	4.3	5.5	6.7	kΩ
DC Transfer Ratio Compensation Amp Gain	A _{V7}	_	(Note 3)	0.25	0.34	0.45	_
Dynamic ABL Maximum Sensitivity	G _{V6}	_	(Note 4)	3.4	5	6.6	mV / μA
Black Stretch Amp Maximum Gain	G _{VBE}	_	(Note 5)	1.30	1.40	1.50	_
Y Input Dynamic Range	DR ₁	_	(Note 6)	0.9	1.0	1.2	V
Luminance Transient Control Peaking Frequency	F _P	_	(Note 7)	3.6	4	4.4	MHz
Luminance Transient Control Range	G _{SMAX}	_	(Note 8)	9	12	15	- dB
	G _{SMIN}			-12	-9	-6	
Luminance Transient Control Center Characteristics	G _{SCT}	_	(Note 9)	4	5.5	7	dB
Peaking Frequency Change Range	FP _{MAX}	_	(Note 10)	4.3	5.9	7.8	MHz
	FP _{MIN}			1.8	2.7	3.6	

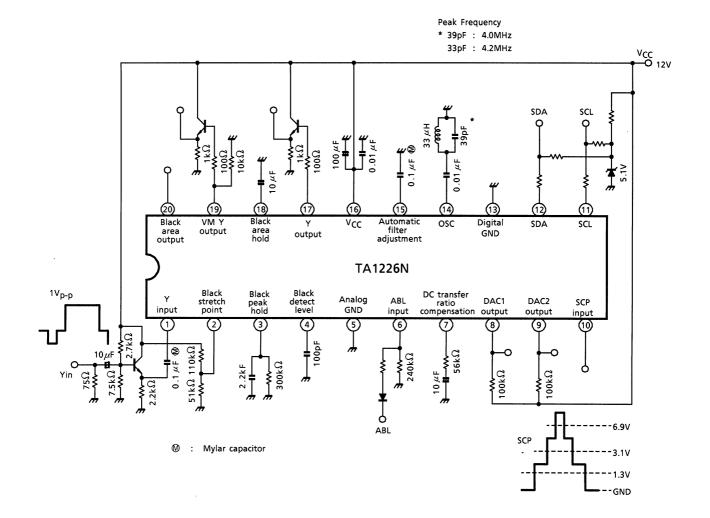
TA1226N

CHARACTERISTIC	SYMBOL	TEST CIR- CUIT	TEST CONDITION	MIN	TYP.	MAX	UNIT
Super Real Transient 2T Pulse Response	SRT _{MAX}		(Note 11)	20	40	60	ns
	SRT _{CEN}			110	130	150	
	SRT _{MIN}			170	190	210	
Noise Reduce	GNR	_	(Note 12)	-15	-7	-1.0	dB
Black Stretch Point	V _{ST1}	_	(Note 13)	250	310	370	- mV
	V _{ST2}			340	430	520	
Black Peak Detect On Voltage	V _{BPON}	_	(Note 14)	1.2	1.5	1.8	V
Black Detect Delay Time	T _{BP1}	_	(Note 15)	0 50	170	20	
	T _{BP2}		(Note 15)	U	30	170	ns
VM Output Y Gain	G _{VM00}		(Note 16)	_	-40	-20	- dB
	G _{VM01}			-7	-6	- 5	
	G _{VM10}	-		-4	-3	-2	
	G _{VM11}			-1	0	1	
γ Correction Point	V _Y 00		(Note 17)	530	575	620	mV
	V _{γ01}			600	645	690	
	V _{γ10}			620	665	710	
γ Correction Curve	G _Y 0	_	(Note 18)	-3.2	-2.4	-1.6	dB
	G _{γ1}			-2.4	-1.6	-0.8	
Black Peak Detect Level	V _{BP}	_	(Note 19)	5	20	35	mV
DL APACON Limiter Range	V _{AL}	_	(Note 20)	20	45	70	mV
Black Area Detected Level	V _{BS00}		(Note 21)	50	80	110	mV
	V _{BS01}			130	160	190	
	V _{BS10}			200	230	260	
	V _{BS11}			280	310	340	
Black Area Hold Pin Voltage	ΔV _{BS00}	- - -	(Note 22)				
	ΔV _{BS01}			-260		000	
Black Area Output Pin Voltage Difference	ΔV _{BS10}				0	260	mV
	ΔV _{BS11}						
Black Area Output Pin Voltage Change With Respect To Black Area Hold Pin Voltage Change	ΔV ₂₀₀₀		(Note 23)	410 500	500	040	>/
	ΔV ₂₀₀₁						
	ΔV ₂₀₁₀				610	mV	
	ΔV ₂₀₁₁						
Frequency Characteristics Compensation	FT _{MAX}	_	(Note 24)	5	6	7	- dB
	FT _{MIN}			-1.5	0	-1.5	
Clamp Voltage On Voltage	V _{CLON}	_	(Note 25)	6.7	6.9	7.1	V
Horizontal Blanking On Voltage	V _{HP}	_	_	2.9	3.1	3.3	V
Vertical Blanking On Voltage	V _{VP}	_	_	1.1	1.3	1.5	V
OSC Oscillation Frequency	Fosc	_	(Note 26)	3.9	4.0	4.1	MHz

TEST CIRCUIT



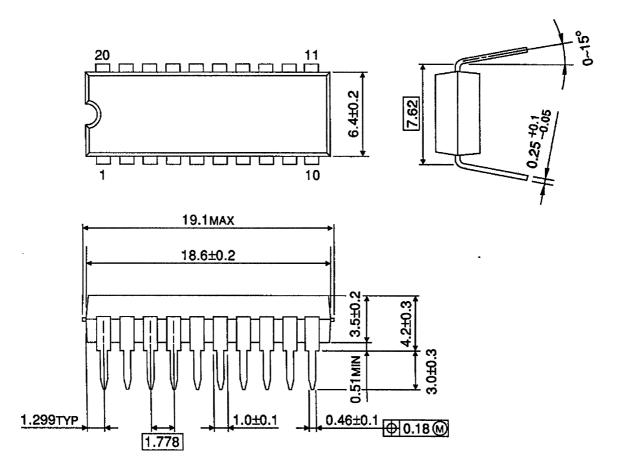
APPLICATION CIRCUIT



Unit: mm

PACKAGE DIMENSIONS

SDIP20-P-300-1.78



Weight: 1.02g (Typ.)